IRFZ10

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

 $R_{DS(on)}(\Omega)$

Q_{qs} (nC)

Q_{qd} (nC)

Q_a (Max.) (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

0.20

60

11

3.1

5.8

Single

V_{GS} = 10 V

FEATURES

- Dynamic dV/dt rating
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provides the designer with the best combination of fast switching, ruggedized device design, low on-resistance, and cost effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFZ10PbF

ABSOLUTE MAXIMUM RATINGS ($T_c = 25$ °C, unless otherwise noted)									
PARAMETER			SYMBOL	LIMIT	UNIT				
Drain-source voltage			V _{DS}	60	v				
Gate-source voltage			V _{GS}	± 20	v				
Continuous drain current	V _{GS} at 10 V	T _C = 25 °C	- I _D	10					
		T _C = 100 °C		7.2	А				
Pulsed drain current ^a			I _{DM}	40					
Linear derating factor				0.29	W/°C				
Single pulse avalanche energy ^b			E _{AS} 47		mJ				
Maximum power dissipation	T _C =	25 °C	PD	43	W				
Peak diode recovery dV/dt ^c			dV/dt 4.5		V/ns				
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +175					
Soldering recommendations (peak temperature)	For 10 s			300 ^d	- °C				
Mounting torque	6-32 or M3 screw			10	lbf · in				
				1.1	N · m				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 1.8 mH, $R_g = 25 \Omega$, $I_{AS} = 7.2 \text{ A}$ (see fig. 12)

c. $I_{SD} \le 10$ A, dI/dt ≤ 90 A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C

d. 1.6 mm from case

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	- 62 0.50 -				°C/W		
Case-to-sink, flat, greased surface	R _{thCS}							
Maximum junction-to-case (drain)	R _{thJC}	- 3.5						
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	Inless otherw	ise noted)						
PARAMETER	SYMBOL	TEST	CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0$	0 V, I _D = 2	50 µA	60	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C,	I _D = 1 mA	-	0.063	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V$	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$			-	4.0	V
Gate-source leakage	I _{GSS}	$V_{GS} = \pm 20$			-	-	± 100	nA
Zero gate voltage drain current	la	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$		= 0 V	-	-	25	
Zero gate voltage drain current	$V_{DS} = 48 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{\text{J}} = 150 ^{\circ}\text{C}$		T _J = 150 °C	-	-	250	μA	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	Ic	₀ = 6.0 A ^b	-	-	0.20	Ω
Forward transconductance	9 _{fs}	$V_{DS}=25 \text{ V}, \text{ I}_{D}=6.0 \text{ A}^{\text{ b}}$		2.4	-	-	S	
Dynamic								
Input capacitance	C _{iss}	$V_{GS} = 0 V$			-	300	-	pF
Output capacitance	C _{oss}	V	V _{DS} = 25 V			160	-	
Reverse transfer capacitance	C _{rss}	f = 1.0 MHz, see fig. 5			-	29	-	
Total gate charge	Qg				-	-	11	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 10 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 ^b		-	-	3.1	nC
Gate-drain charge	Q _{gd}		566 1	ig. 0 and 15-	-	-	5.8	
Turn-on delay time	t _{d(on)}				-	10	-	
Rise time	t _r	V _{DD} = 30 V, I _D = 10 A			-	50	-	ns
Turn-off delay time	t _{d(off)}	$R_{g} = 24 \Omega$, $R_{D} = 2.7 \Omega$, see fig. 10 ^b		-	13	-		
Fall time	t _f	$n_g = 24$ sz, $n_D = 2.7$ sz, see lig. 10 -			-	19	-	
Internal drain inductance	L _D	Between lead, 6 mm (0.25") fro	لر			4.5	-	nH
Internal source inductance	L _S	package and center of die contact			-	7.5	-	
Drain-Source Body Diode Characteristi	cs	•					4	ļ
Continuous source-drain diode current	١ _S	MOSFET symbol showing the		-	-	10	A	
Pulsed diode forward current ^a	I _{SM}	p - n junction diode			-	-		40
Body diode voltage	V _{SD}	T_J = 25 °C, I_S = 10 A, V_{GS} = 0 V ^b			-	-	1.6	V
Body diode reverse recovery time	t _{rr}	$T_{1} = 25 \circ C_{1} = 10 \wedge dt/dt = 100 \wedge t/ch$		-	70	140	ns	
Body diode reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}^b$			-	0.20	0.40	μC
Forward turn-on time	t _{on}	Intrinsic turn-	-on is do	dominated by L_S and L_D)				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

2

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

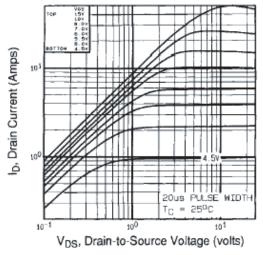


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

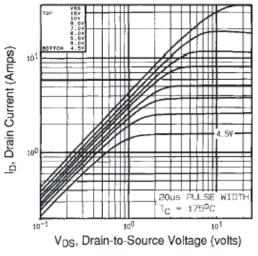


Fig. 2 - Typical Output Characteristics, T_C = 175 $^\circ C$

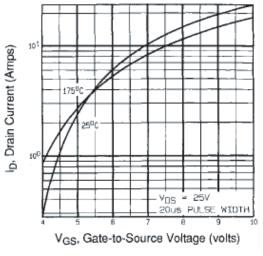


Fig. 3 - Typical Transfer Characteristics

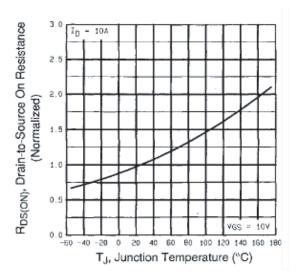
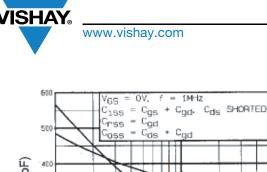


Fig. 4 - Normalized On-Resistance vs. Temperature

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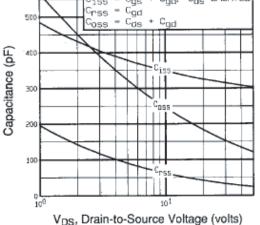


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

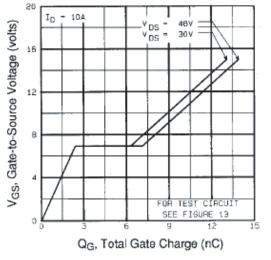


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

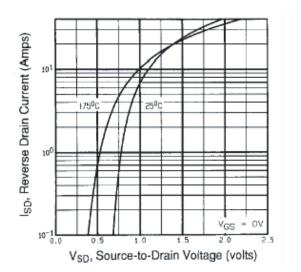
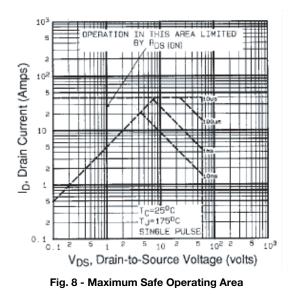


Fig. 7 - Typical Source-Drain Diode Forward Voltage



4

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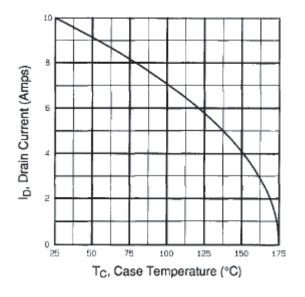


Fig. 9 - Maximum Drain Current vs. Case Temperature

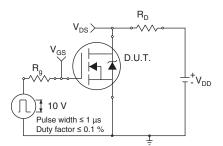


Fig. 10a - Switching Time Test Circuit

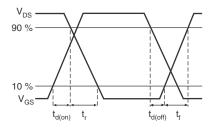


Fig. 10b - Switching Time Waveforms

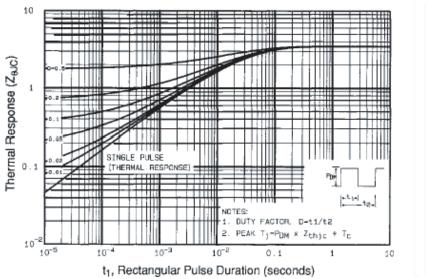


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



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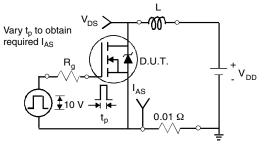


Fig. 12a - Unclamped Inductive Test Circuit

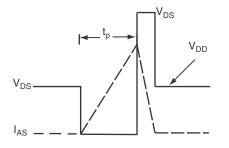


Fig. 12b - Unclamped Inductive Waveforms

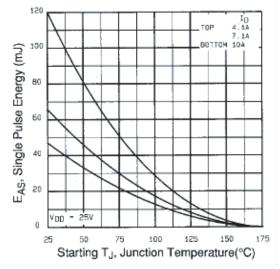
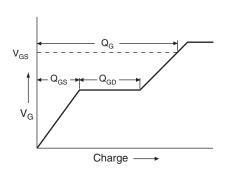


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





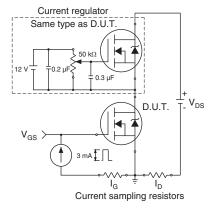


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

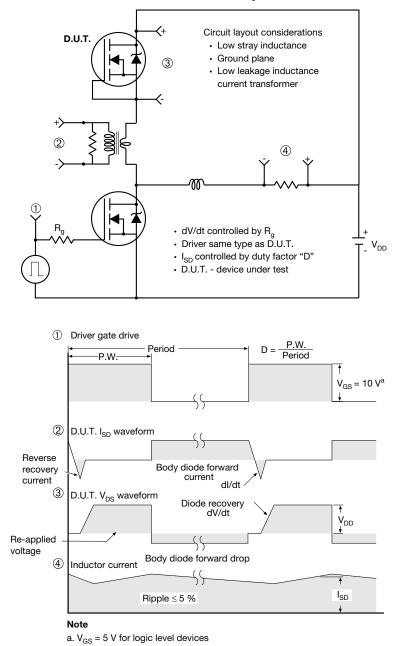


Fig. 14 - For N-Channel

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7



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